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AMENDMENT TRANSMITTAL LETTERDocket No.
KOM-153/INO/DIV2Application No.
10/762,243Filing Date
January 23, 2004Examiner
Jason L. SavageArt Unit
1775

Applicant(s): Takemori Takayama et al

Invention: COPPER BASED SINTERED CONTACT MATERIAL AND DOUBLE-LAYERED SINTERED CONTACT MEMBER

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	14	- 20 =		x	
Independent Claims	1	- 3 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					

 Large Entity Small Entity No additional fee is required for this amendment. Please charge Deposit Account No. 18-0013 in the amount of \$. A duplicate copy of this sheet is enclosed. A check in the amount of \$ to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. The Director is hereby authorized to charge and credit Deposit Account No. 18-0013 as described below. A duplicate copy of this sheet is enclosed. Credit any overpayment. Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Dated: July 22, 2005

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KOM-153/INO/DIV2
(80296-0022)



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Patent Application of

Takemori Takayama et al

Application No.: 10/762,243

Art Unit: 1775

Filed: January 23, 2004

Examiner: Jason L. Savage

For: COPPER BASED SINTERED CONTACT MATERIAL AND DOUBLE-LAYERED
SINTERED CONTACT MEMBER

AMENDMENT

MS PATENT APPLICATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In full and timely response to the Office Action dated May 17, 2005, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification updating the status of the parent application which begins at page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.